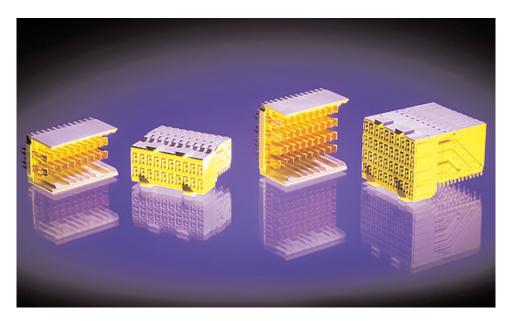


Product Facts

- Z-PACK HM-Zd is an extension of the Z-PACK 2mm HM product line
- Designed specifically for high speed differential applications
- A modular connector system with a standard module size of 25mm
- Contact pitch is 1.5mm within a pair and 3.0mm pair to pair within a column; column to column pitch is 2.5mm
- Card Pitch is less than 0.8 inch for 2 pair headers and 1.0 inch for 4 pair headers
- Available in two versions:
 - 2 signal contact pairs per column (20 pairs per 25mm) compatible with 5 row Z-PACK 2mm HM
 - 4 signal contact pairs per column (40 pairs per 25mm) compatible with 8 row Z-PACK 2mm HM
- Available in vertical press fit pin headers and right angle press fit receptacles
- Optimized footprint for improved electrical performance and ease of trace routing (unobstructed routing channels on both daughtercard and backplane)
- Pin header and receptacle have the exact same footprint to simplify PC board layout
- Designed to meet Telcordia requirements



Z-PACK HM-Zd is a high speed, differential connector system, which is compatible with the Z-PACK 2mm HM connector line. Z-PACK HM-Zd provides Z-PACK 2mm HM users with a migration path for serial switching applications from 3.125Gbps to 6.4Gbps. Z-PACK HM-Zd has also been demonstrated at 10Gbps data rates using SerDes technology.

The Z-PACK HM-Zd connector system features a highly reliable dual beam contact system with fully encompassing grounds dedicated to each differential pair. In addition, the Z-PACK HM-Zd footprint is optimized for both routability and system performance with the use of a 1.5mm x 2.5mm row to column grid. The connector design also features a robust mating interface with integral pre alignment and polarization built into the mating interface.

Availability

- Fully validated SPICE models: E-mail requests to modeling@tycoelectronics.com
- Samples: go to http://amp.custhelp.com
- Pro/E models and IGES models: E-mail requests to ampmodels@tycoelectronics.com
- White Papers:

Electrical Performance Report:

http://www.amp.com/simulation/files/papers/20GC014_RevB.pdf

Routing guide: http://www.amp.com/simulation/files/papers/20GC015_1_RevA.pdf

http://hmzd.tycoelectronics.com

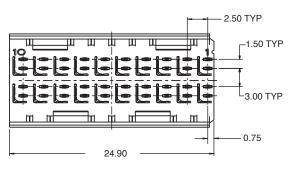


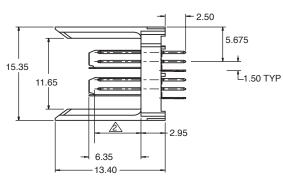


2 Pair 10 Column Assembly

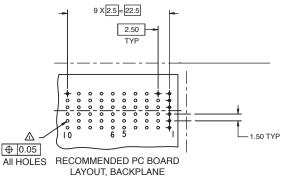
Part Number PIN Length 🖎

1469025-1 5.30 1469025-2 3.80

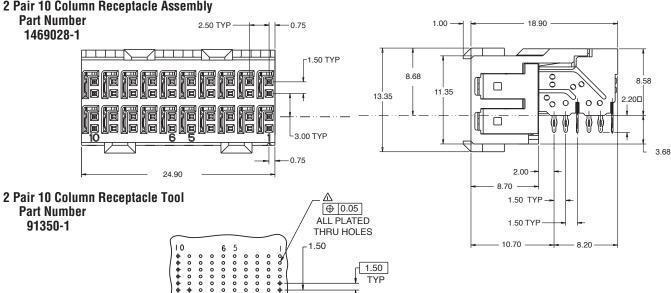




2 Pair 10 Header Insertion Tool **Part Number** 91348-1



2 Pair 10 Column Receptacle Assembly



TYP

9 X 2.5 = 22.5 RECOMMEND PC BOARD LAYOUT, DAUGHTER BOARD, COMPONENT SIDE SHOWN

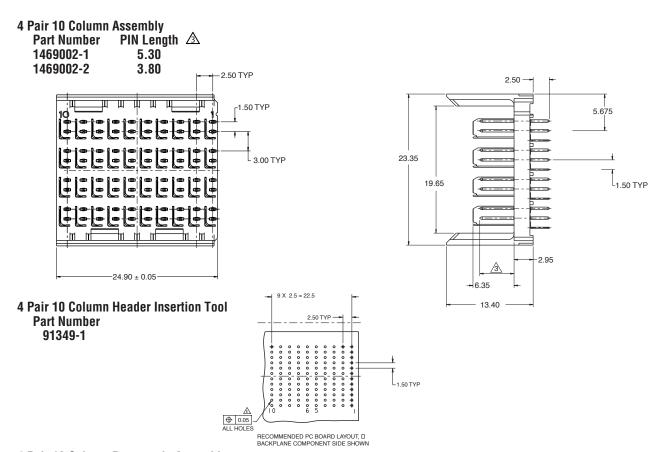
2.50

METRIC

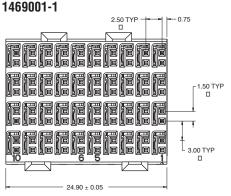
millimeters over inches

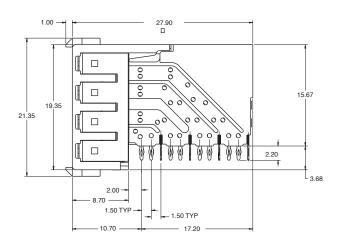
Dimensions are





4 Pair 10 Column Receptacle Assembly Part Number





4 Pair 10 Column Receptacle Insertion Tool



91347-1

1.50C
TYP
9 X 2.5 = 22.5

RECOMMENDED PC BOARD LAYOUT I

DAUGHTER BOARD, COMPONENT SIDE SHOWN

 \triangle PCB HOLE DIM.

DRILLED HOLE = 0.7000 \pm 0.025mm

FINISHED HOLE = 0.60 \pm 0.05mm

Cu - THICKNESS = 0.375 \pm 0.0125mm

SnPb THICKNESS = 0.007 \pm 0.003mm

TYCO and Z-PACK are trademarks.